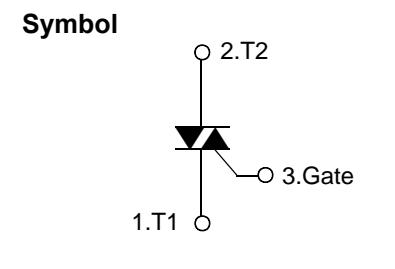


Bi-Directional Triode Thyristor

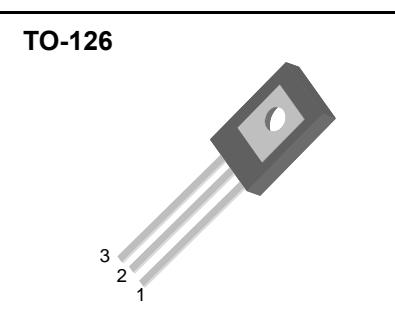
Features

- ◆ Repetitive Peak Off-State Voltage : 600V
- ◆ R.M.S On-State Current ($I_{T(RMS)} = 4 \text{ A}$)
- ◆ High Commutation dv/dt



General Description

This device is new surface mounted package line up suitable for space limited application such as low power AC switching applications, such as fan speed, small light controllers and home appliance equipment.



Absolute Maximum Ratings ($T_J = 25^\circ\text{C}$ unless otherwise specified)

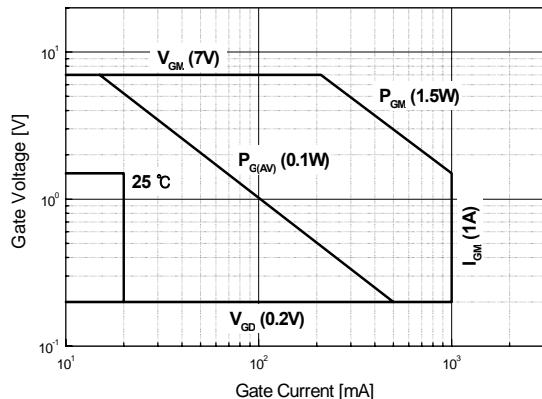
Symbol	Parameter	Condition	Ratings	Units
V_{DRM}	Repetitive Peak Off-State Voltage		600	V
$I_{T(RMS)}$	R.M.S On-State Current	$T_C = 95^\circ\text{C}$	4.0	A
I_{TSM}	Surge On-State Current	One Cycle, 50Hz/60Hz, Peak, Non-Repetitive	30/33	A
I^2t	I^2t		4.5	A^2s
P_{GM}	Peak Gate Power Dissipation		1.5	W
$P_{G(AV)}$	Average Gate Power Dissipation		0.1	W
I_{GM}	Peak Gate Current		1	A
V_{GM}	Peak Gate Voltage		7.0	V
T_J	Operating Junction Temperature		- 40 ~ 125	$^\circ\text{C}$
T_{STG}	Storage Temperature		- 40 ~ 150	$^\circ\text{C}$
	Mass		0.26	g

STR4A60

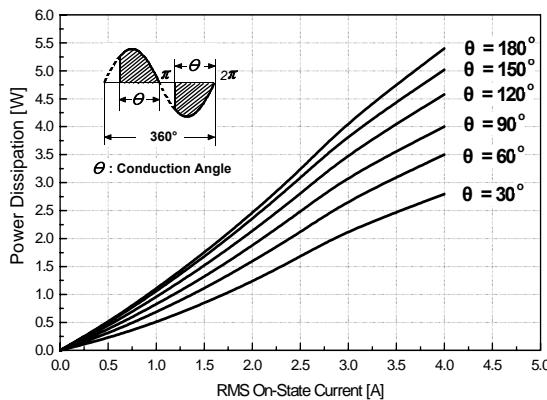
Electrical Characteristics

Symbol	Items	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I_{DRM}	Repetitive Peak Off-State Current	$V_D = V_{DRM}$, Single Phase, Half Wave $T_J = 125^\circ C$	—	—	1.0	mA
V_{TM}	Peak On-State Voltage	$I_T = 6.0 A$, Inst. Measurement	—	—	1.6	V
I^+_{GT1}	I	Gate Trigger Current	—	—	20	mA
I^-_{GT1}	II		—	—	20	
I^-_{GT3}	III		—	—	20	
V^+_{GT1}	I	Gate Trigger Voltage	—	—	1.5	V
V^-_{GT1}	II		—	—	1.5	
V^-_{GT3}	III		—	—	1.5	
V_{GD}	Non-Trigger Gate Voltage	$T_J = 125^\circ C$, $V_D = 1/2 V_{DRM}$	0.2	—	—	V
$(dv/dt)_c$	Critical Rate of Rise Off-State Voltage at Commutation	$T_J = 125^\circ C$, $[di/dt]_c = -2.0 A/ms$, $V_D=2/3 V_{DRM}$	5.0	—	—	V/ μ s
I_H	Holding Current		—	5.0	—	mA
$R_{th(j-c)}$	Thermal Impedance	Junction to case	—	—	3.5	°C/W

Fig 1. Gate Characteristics



**Fig 3. On State Current vs.
Maximum Power Dissipation**



**Fig 5. Surge On-State Current Rating
(Non-Repetitive)**

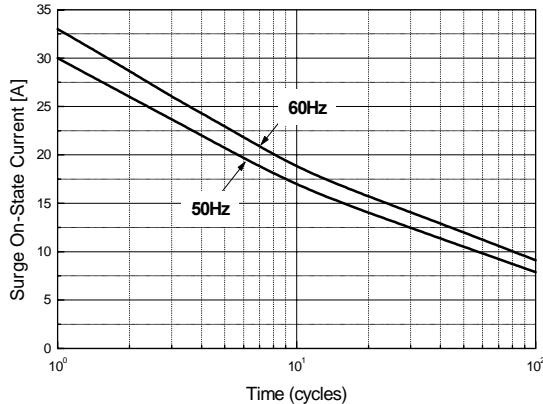
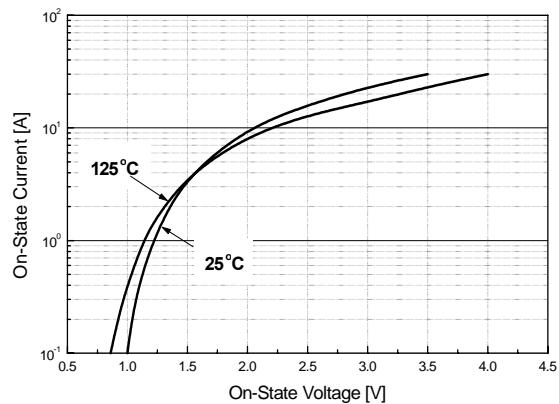
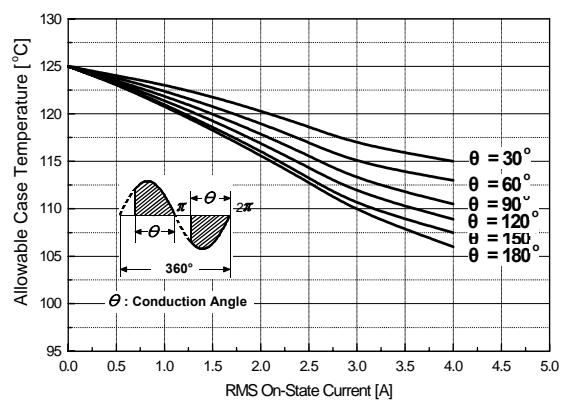


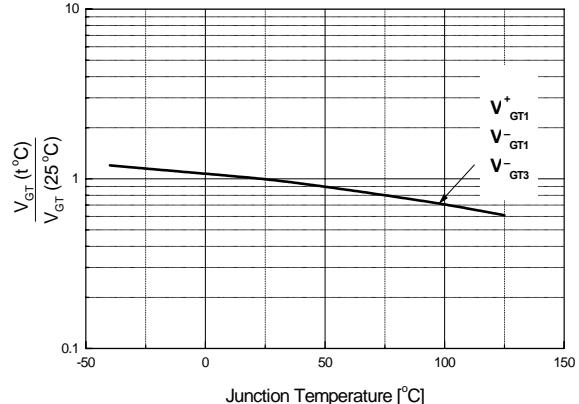
Fig 2. On-State Voltage



**Fig 4. On State Current vs.
Allowable Case Temperature**



**Fig 6. Gate Trigger Voltage vs.
Junction Temperature**



STR4A60

Fig 7. Gate Trigger Current vs. Junction Temperature

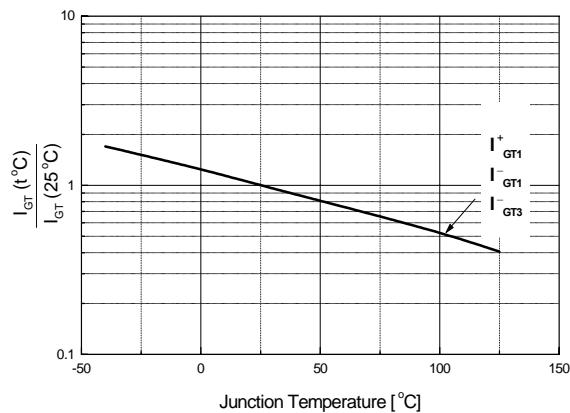


Fig 8. Transient Thermal Impedance

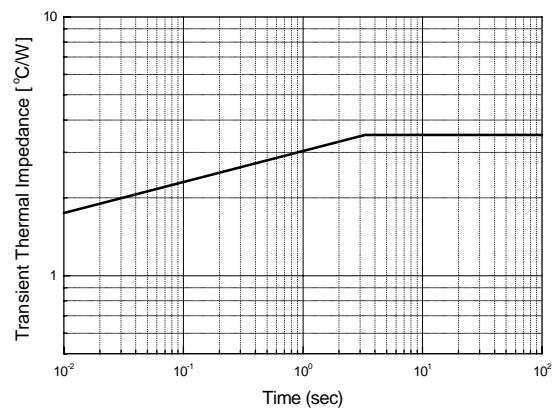
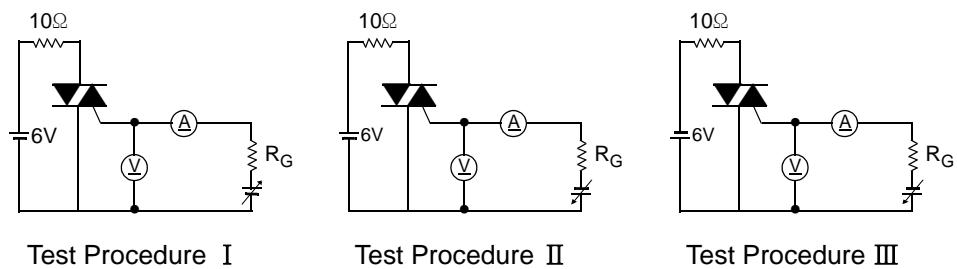


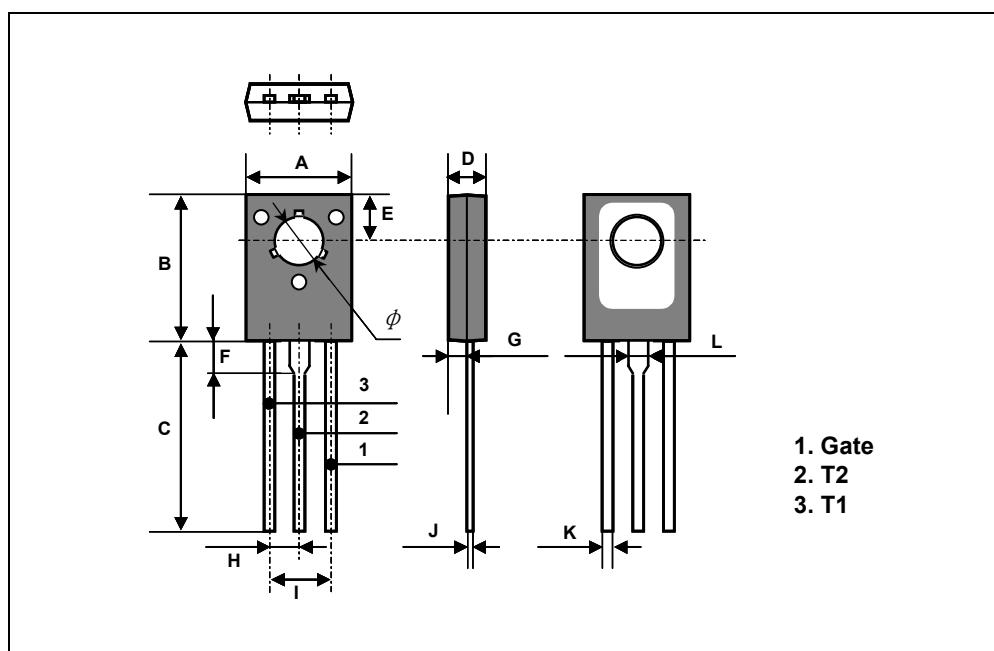
Fig 9. Gate Trigger Characteristics Test Circuit



STR4A60

TO-126 Package Dimension

Dim.	mm			Inch		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	7.5		7.9	0.295		0.311
B	10.8		11.2	0.425		0.441
C	14.2		14.7	0.559		0.579
D	2.7		2.9	0.106		0.114
E		3.8			0.150	
F		2.5			0.098	
G	1.2		1.5	0.047		0.059
H		2.3			0.091	
I		4.6			0.181	
J	0.48		0.62	0.019		0.024
K	0.7		0.86	0.028		0.034
L		1.4			0.055	
ϕ		3.2			0.126	



STR4A60

TO-126 Package Dimension, Forming

Dim.	mm			Inch		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	7.5		7.9	0.295		0.311
B	10.8		11.2	0.425		0.441
C	14.2		14.7	0.559		0.579
D	2.7		2.9	0.106		0.114
E		3.8			0.150	
F		2.5			0.098	
G	1.2		1.5	0.047		0.059
H		2.3			0.091	
I		4.6			0.181	
J	0.48		0.62	0.019		0.024
K	0.7		0.86	0.028		0.034
L		1.4			0.055	
M		5.0			0.197	
ϕ		3.2			0.126	

